## SUM70090E

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**Vishay Siliconix** 

## N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	(V) R <sub>DS(on)</sub> (Ω) MAX.		Q <sub>g</sub> (TYP.)			
100	0.0089 at $V_{GS}$ = 10 V	50	33 nC			
	0.0093 at $V_{GS}$ = 7.5 V	50	33110			



#### Ordering Information:

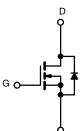
SUM70090E-GE3 (lead (Pb)-free and halogen-free)

#### FEATURES

- ThunderFET<sup>®</sup> power MOSFET
- Maximum 175 °C junction temperature
- Q<sub>gd</sub> / Q<sub>gs</sub> ratio < 1 optimizes switching characteristics</li>
- 100 %  $\rm R_g$  and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Power supply
  Secondary synchronous rectification
- DC/DC converter
- Power tools
- Motor drive switch
- DC/AC inverter
- Battery management



**RoHS** COMPLIANT

HALOGEN

FREE

N-Channe	MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	100	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	v			
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 25 °C		50 °			
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	50 <sup>c</sup>	A		
Pulsed Drain Current (t = 100 µs)	I <sub>DM</sub>	120	A			
Avalanche Current	I <sub>AS</sub>	40	1			
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	80	mJ		
Maximum Dawar Dissinction a	T <sub>C</sub> = 25 °C		125	w		
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 70 °C <sup>b</sup>	– P <sub>D</sub> –	87.5	VV		
Operating Junction and Storage Temperature F	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C			

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) <sup>b</sup>	R <sub>thJA</sub>	R <sub>thJA</sub> 40 °C/W			
Junction-to-Case (Drain)	R <sub>thJC</sub>	1.2	C/W		

#### Notes

- a. Duty cycle  $\leq$  1 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. Package limited.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	100	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},\ I_D=250\ \mu A$	2	-	4	- V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V	-	-	± 250	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C	-	-	150	μA	
		$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 $^{\circ}\text{C}$	-	-	5	mA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 10 \text{ V},  V_{GS} = 10 \text{ V}$	50	-	-	А	
Drain Source On State Registeres a	P	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	0.0074	0.0089	0	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.0077	0.0093	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A	-	38	-	S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 50 V, f = 1 MHz	-	1950	-	pF	
Output Capacitance	C <sub>oss</sub>		-	845	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	54	-		
Total Gate Charge <sup>c</sup>	Qg		-	33	50	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}=50$ V, $V_{GS}=10$ V, $I_{D}=20$ A	-	8.8	-		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>		-	7.5	-		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.7	3.5	7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		-	15	30		
Rise Time <sup>c</sup>	tr	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 5 \Omega$	-	27	54		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ 10 Å, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	-	36	72	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>		-	45	90		
Drain-Source Body Diode Ratings an	nd Characteri	stics <sup>b</sup> (T <sub>C</sub> = 25 °C)					
Pulsed Current (t = 100 µs)	I <sub>SM</sub>		-	-	120	А	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>		-	77	116	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	-	4.2	6.3	Α	
Reverse Recovery Charge	Q <sub>rr</sub>	-1 1		145	365	nC	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

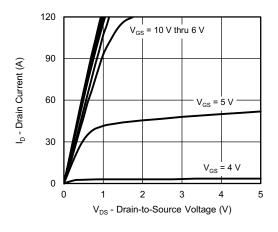
2



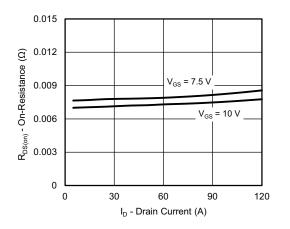
# SUM70090E

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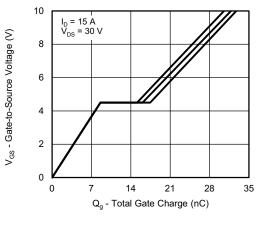
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



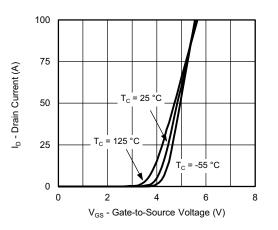
**Output Characteristics** 



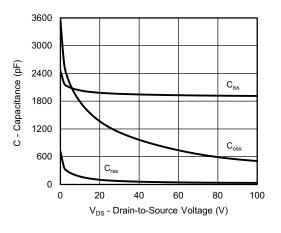
**On-Resistance vs. Drain Current** 



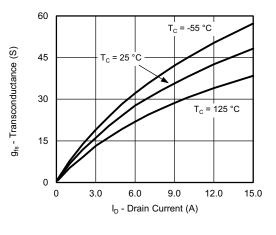
Gate Charge



**Transfer Characteristics** 



Capacitance



Transconductance

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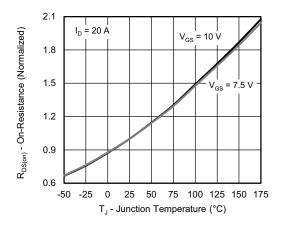
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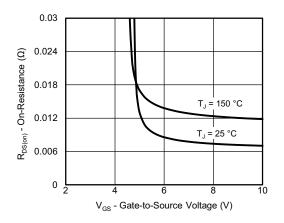
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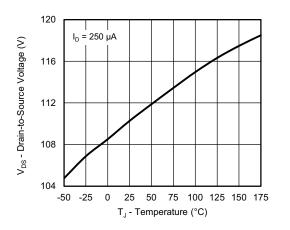
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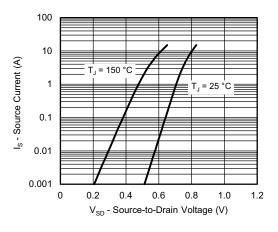
**On-Resistance vs. Junction Temperature** 



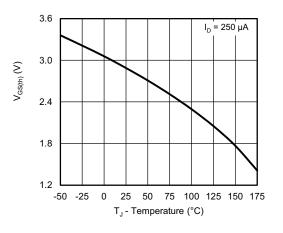
On-Resistance vs. Gate-to-Source Voltage



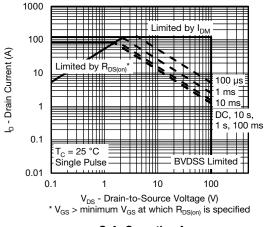
Drain Source Voltage vs. Junction Temperature



Source Drain Diode Forward Voltage



**Threshold Voltage** 



Safe Operating Area

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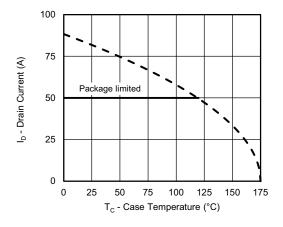
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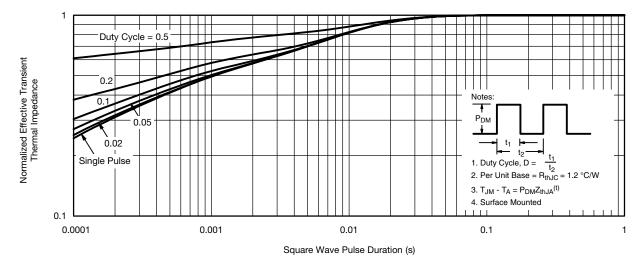


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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



**Current De-Rating** 



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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**Vishay Siliconix** 

TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIN	IETERS
DIM.		MIN.	MAX.	MIN.	MAX.
	А	0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
с*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
CI	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	E	0.380	0.410	9.652	10.414
	E1	0.245	-	6.223	-
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100 BSC		2.54 BSC	
	К	0.045	0.055	1.143	1.397
	L	0.575	0.625	14.605	15.875
	L1	0.090	0.110	2.286	2.794
L2		0.040	0.055	1.016	1.397
	L3	0.050	0.070	1.270	1.778
L4		0.010 BSC		0.254 BSC	
М		-	0.002	-	0.050
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843					

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



## **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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